200mm Semi-Automatic Wafer Mounter



JOm/8

Facility

**Power Supply** 

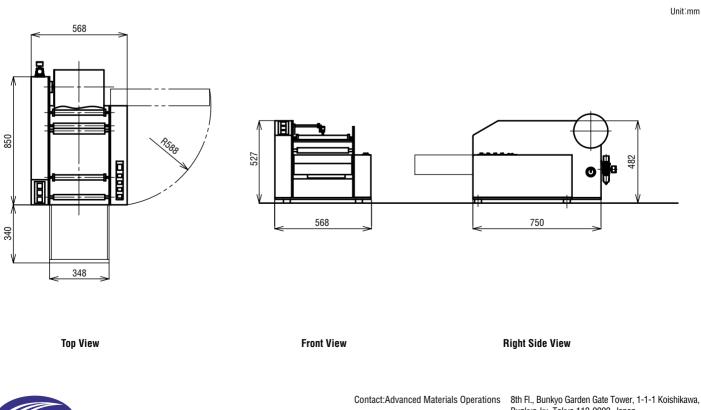
## Outline

-Semi-automatic wafer mounter that mounts wafer onto the pre-cut dicing tape once the operator supplies the wafer and ring frame by hand.

Options	Static Eliminator
	•Top Cover
	·Wafer Positioning Pins
Suitable Tapes	•Pre-cut dicing tape : Adwill D series, G series

·Dicing die bonding tape : Adwill LE Tape

## External View



Air Supply	Phase Power consumption Air pressure Air consumption	: single phase : 0.2kW : 0.5-0.8MPa : >150L/min (ANR)	
Applicable Wafer Size	200mm Additional compatibility with various wafer sizes and shapes are available as an option. Please feel free to inquire.		
Size	Width : 568mm Depth : 850mm (with table fully advan Height : 527mm	iced : Max.1,190mm)	
Weight	90kg		
Processing Capasity	18sec/wafer (excludes	s setting time)	

Voltage

Frequency

: AC100V (±10%) : 50/60Hz

will give you the Advantage

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Bunkyo-ku, Tokyo 112-0002, Japan TEL. +81-3-3868-7737 FAX. +81-3-3868-7726